

Title (en)

Method and apparatus for the manufacture of metallic surface layers on substrates

Title (de)

Verfahren und Vorrichtung zur Herstellung metallischer Flächenelemente auf Substraten

Title (fr)

Méthode et appareil pour la fabrication d'éléments métalliques surfaces sur substrats

Publication

**EP 0563992 B1 19980715 (DE)**

Application

**EP 93105519 A 19930402**

Priority

DE 4211235 A 19920403

Abstract (en)

[origin: EP0563992A2] A novel method for manufacturing substrates with defined metallic surface structure is specified, which method can be used advantageously in particular in the manufacture of reflection holograms on banknotes. In this case the metallic surface elements are produced on a master, for example a printing roller, in peelable form and then transferred directly from the master onto the respective substrate. <IMAGE>

IPC 1-7

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IPC 8 full level

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CPC (source: EP US)

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